Supplier Name: Texas Instruments Inc. (DUNS# 00-732-1904)

Contact Info: ti.com/support

Distribute - RoHS and IEC 62474 DB Form/Declaration Type:

06/05/2022 Created on:

Details for "SM72485MMX/NOPB"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
SM72485MMX/NOPB	SN	Level-1-260C-UNLIM	Texas Instruments Electronics	DGK 8	3 x 3 x 1	31.2

*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS		REACH	Green	IEC 62474 DB	
	Yes	Yes	Yes	Yes	

Component Information

				Homogeneous Material Level		Component Level	
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Bond Wire							
Copper and Its Alloys	Copper	7440-50-8	0.044201	98.73347	987335	0.141501	1415
Not Categorized	Proprietary Materials		0.000005	0.011169	112	0.000016	0
Precious Metals	Gold	7440-57-5	0.00001	0.022337	223	0.000032	0
Precious Metals	Palladium	7440-05-3	0.000551	1.23079	12308	0.001764	18
Precious Metals	Silver	7440-22-4	0.000001	0.002234	22	0.000003	0
Sub-Total			0.044768	100	1000000	0.143316	1433
Die Attach Adhesive							
Precious Metals	Silver	7440-22-4	0.446249	74.999958	750000	1.428575	14286
Thermoplastics	Epoxy	85954-11-6	0.14875	25.000042	250000	0.476193	4762
Sub-Total			0.594999	100	1000000	1.904768	19048
Lead Frame							
Copper and Its Alloys	Copper	7440-50-8	14.618636	96.550003	965500	46.798588	467986
Copper and Its Alloys	Iron	7439-89-6	0.360356	2.380001	23800	1.153606	11536
Copper and Its Alloys	Phosphorus	7723-14-0	0.004542	0.029998	300	0.01454	145
Precious Metals	Silver	7440-22-4	0.139297	0.919999	9200	0.445931	4459
Zinc and Its Alloys	Zinc	7440-66-6	0.018169	0.119999	1200	0.058164	582
Sub-Total			15.141	100	1000000	48.47083	484708
Lead Frame Plating							
Other Nonferrous Metals and Alloys	Tin	7440-31-5	1.15	100	1000000	3.681491	36815
Sub-Total			1.15	100	1000000	3.681491	36815
Mold Compound							
Other Inorganic Materials	Fused Silica	60676-86-0	11.21129	89	890000	35.890663	358907
Other Nonferrous Metals and Alloys	Metal Hydroxide	Trade Secret	0.377909	3.000003	30000	1.209799	12098
Thermoplastics	Epoxy	85954-11-6	1.007756	7.999997	80000	3.226126	32261
Sub-Total			12.596955	100	1000000	40.326588	403266
Semiconductor Device		•	·			·	
Ceramics / Glass	Doped Silicon	7440-21-3	1.709622	100	1000000	5.473007	54730
Sub-Total Sub-Total			1.709622	100	1000000	5.473007	54730
Total			31.237344			100	1000000

Important Note

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The ppm calculations are at the component level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the component See Glossary of Terms for more details.

Important Part Information

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

Product Content Methodology
For an explanation of the methods used to determine material weights, See Product Content Methodology

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database

Important Information/Disclaimer

TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is." For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 06/05/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

ROHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szqq088

Green: Means the content of Chiorine (CI) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.